# **MA2SD310G**

### Silicon epitaxial planar type

For super high speed switching

#### Features

- $I_{F(AV)} = 200$  mA rectification is possible.
- Low forward voltage:  $V_F < 0.47$  V (at  $I_F = 200$  mA)

Absolute Maximum Ratings $T_a = 25^{\circ}C$						
Parameter	Symbol	Rating	Unit			
Reverse voltage	V <sub>R</sub>	30	v			
Repetitive peak reverse voltage	V <sub>RRM</sub>	30	V			
Forward current (Average)	I <sub>F(AV)</sub>	200	mA			
Peak forward current	I <sub>FM</sub>	300	mA			
Non-repetitive peak forward surge current *	I <sub>FSM</sub>	1	А			
Junction temperature	Tj	125	°C			
Storage temperature	T <sub>stg</sub>	-55 to +125	°C			

Package
Code

- SSMini2-F4 • Pin Name
- 1: Anode
- 2: Cathode
- Marking Symbol: 8F

Note) \* : The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

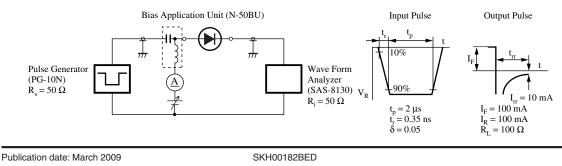
#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage		V <sub>F</sub>	$I_{\rm F} = 200  {\rm mA}$		0.38	0.47	V
Reverse current		I <sub>R1</sub>	V <sub>R</sub> = 10 V	00	SOL	20	μΑ
		I <sub>R2</sub>	$V_R = 30 V$		0-	200	
Terminal capacitance	~	C <sub>t</sub>	$V_R = 0 V, f = 1 MHz$	2.2	25		pF
Reverse recovery time *		t <sub>rr</sub>	$I_F = I_R = 100 \text{ mA}$		2		ns
			$I_{rr} = 10 \text{ mA}, R_L = 100 \Omega$				

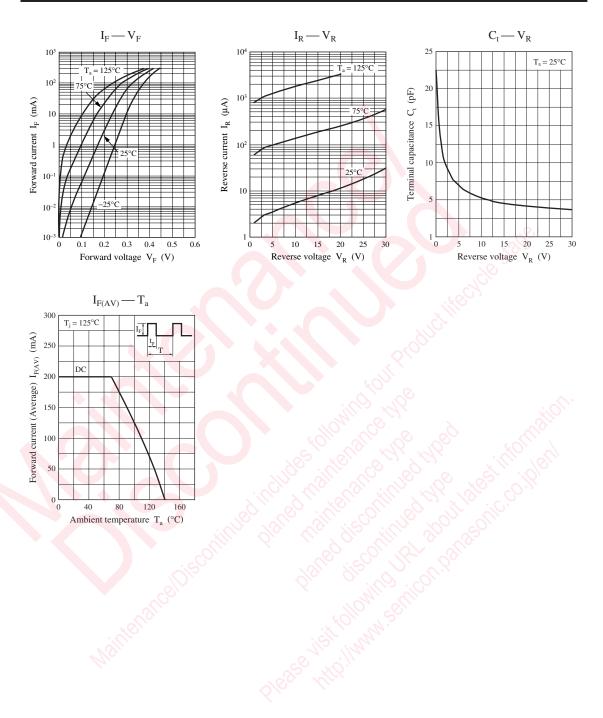
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

- 3. Absolute frequency of input and output is 250 MHz
- 4. \*: t<sub>rr</sub> measurement circuit



### **Panasonic**

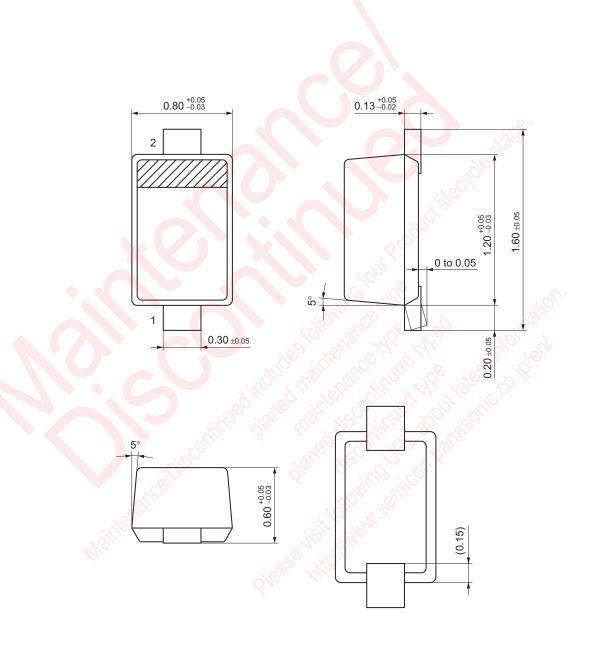


### Panasonic

MA2SD31

SSMini2-F4

Unit: mm



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